FAIRCHILD SEMICONDUCTOR™

May 1998
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NC7SZ175
TinyLogic® UHS D-Type Flip-Flop with Asynchronous Clear

General Description

The NC7SZ175 is a single positive edge-triggered D-type CMOS Flip-Flop with Asynchronous Clear from Fairchild's Ultra High Speed Series of TinyLogic® in the space saving SC70 6-lead package. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V V_{CC} range. The inputs and output are high impedance when V_{CC} is 0V. Inputs tolerate voltages up to 7V independent of V_{CC} operating voltage. This single flip-flop will store the state of the D input that meets the setup and hold time requirements on the LOW-to-HIGH Clock (CP) transition. A LOW input to Clear sets the Q output to LOW level. The Clear input is independent of clock.

Features

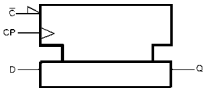
- Space saving SC70 6-lead package
- Ultra small MicroPak™ leadless package
- Ultra High Speed; t_{PD} 2.6 ns Typ into 50 pF at 5V V_{CC}
- High Output Drive; ±24 mA at 3V V_{CC}
- Broad V_{CC} Operating Range; 1.65V to 5.5V
- Matches the performance of LCX when operated at 3.3V V_{CC}
- Power down high impedance inputs/output
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Proprietary noise/EMI reduction circuitry implemented

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7SZ175P6X	MAA06A	Z75	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
NC7SZ175L6X	MAC06A	C4	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Logic Symbol

IEEE/IEC



Function Table

Inputs			Output
CP	D	$\overline{C}$	Q
⌐	L	H	L
⌐	H	H	H
¬	X	H	Qn
X	X	L	L

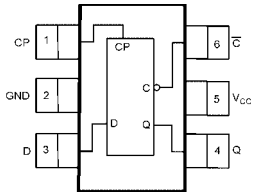
H = HIGH Logic Level Qn = No change in data
L = LOW Logic Level X = Immaterial

Pin Descriptions

Pin Names	Description
D	Data Input
CP	Clock Pulse Input
$\overline{C}$	Clear Input
Q	Flip-Flop Output

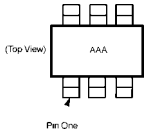
Connection Diagrams

Pin Assignments for SC70



(Top View)

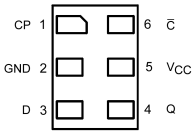
Pin One Orientation Diagram



AAA represents Product Code Top Mark - see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Thru View)

Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{CC})	−0.5V to +7.0V
DC Input Voltage (V_{IN})	−0.5V to +7.0V
DC Output Voltage (V_{OUT})	−0.5V to +7.0V
DC Input Diode Current (I_{IK})	
V_{IN} < 0V	−50 mA
DC Output Diode Current (I_{OK})	
V_{OUT} < 0V	−50 mA
DC Output (I_{OUT}) Source/Sink Current	±50 mA
DC V_{CC}/GND Current (I_{CC}/I_{GND})	±50 mA
Storage Temperature Range (T_{STG})	−65°C to +150°C
Junction Temperature under Bias (T_J)	150°C
Junction Lead Temperature (T_L)	
(Soldering, 10 seconds)	260°C
Power Dissipation (P_D) @+85°C	180 mW

Recommended Operating Conditions (Note 2)

Power Supply	
Operating (V_{CC})	1.65V to 5.5V
Data Retention	1.5V to 5.5V
Input Voltage (V_{IN})	0V to 5.5V
Output Voltage (V_{OUT})	0V to V_{CC}
Input Rise and Fall Time (t_r, t_f)	
V_{CC} = 1.8V, 2.5V ± 0.2V	0 to 20 ns/V
V_{CC} = 3.3V ± 0.3V	0 to 10 ns/V
V_{CC} = 5.5V ± 0.5V	0 to 5 ns/V
Operating Temperature (T_A)	−40°C to +85°C
Thermal Resistance (θ_{JA})	350° C/W

Note 1: The "Absolute Maximum Ratings": are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	T_A = +25°C			T_A = −40°C to +85°C		Unit	Conditions	
			Min	Typ	Max	Min	Max			
V_{IH}	HIGH Level Control Input Voltage	1.65 to 1.95	0.75 V_{CC}			0.75 V_{CC}		V		
		2.3 to 5.5	0.7 V_{CC}			0.7 V_{CC}				
V_{IL}	LOW Level Control Input Voltage	1.65 to 1.95			0.25 V_{CC}		0.25 V_{CC}	V		
		2.3 to 5.5			0.3 V_{CC}		0.3 V_{CC}			
V_{OH}	HIGH Level Control Output Voltage	1.65	1.55	1.65		1.55		V	V_{IN} = V_{IH} or V_{IL}	I_{OH} = −100 µA
		1.8	1.7	1.8		1.7				
		2.3	2.2	2.3		2.2				
		3.0	2.9	3.0		2.9				
		4.5	4.4	4.5		4.4				
		1.65	1.24	1.52		1.29				I_{OH} = −4 mA
		2.3	1.9	2.15		1.9				I_{OH} = −8 mA
		3.0	2.4	2.8		2.4				I_{OH} = −16 mA
		3.0	2.3	2.68		2.3				I_{OH} = −24 mA
		4.5	3.8	4.2		3.8				I_{OH} = −32 mA
V_{OL}	LOW Level Control Output Voltage	1.65		0.0	0.1		0.1	V	V_{IN} = V_{IL} or V_{IH}	I_{OL} = 100 µA
		1.8		0.0	0.1		0.1			
		2.3		0.0	0.1		0.1			
		3.0		0.0	0.1		0.1			
		4.5		0.0	0.1		0.1			
		1.65		0.08	0.24		0.24			I_{OL} = 4 mA
		2.3		0.10	0.3		0.3			I_{OL} = 8 mA
		3.0		0.15	0.4		0.4			I_{OL} = 16 mA
		3.0		0.22	0.55		0.55			I_{OL} = 24 mA
		4.5		0.22	0.55		0.55			I_{OL} = 32 mA
I_{IN}	Input Leakage Current	0 to 5.5			±0.1		±1.0	µA	0 ≤ V_{IN} ≤ 5.5V	
I_{OFF}	Power Off Leakage Current	0.0			1.0		10	µA	V_{IN} or V_{OUT} = 5.5V	
I_{CC}	Quiescent Supply Current	1.65 to 5.5			1.0		10.0	µA	V_{IN} = 5.5V, GND	

AC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = +25°C$			$T_A = -40°C$ to $+85°C$		Units	Conditions	Figure Number
			Min	Typ	Max	Min	Max			
f_{MAX}	Maximum Clock Frequency	1.65				100		MHz	C_L = 50 pF R_L = 500 Ω	Figures 1, 4
		1.8				100				
		2.5 ± 0.2				125				
		3.3 ± 0.3				150				
		5.0 ± 0.5				175				
t_{PLH} t_{PHL}	Propagation Delay CP to Q	1.65	2.5	9.8	15.0	2.5	16.5	ns		
		1.8	2.5	6.5	10.0	2.5	11.0			
		2.5 ± 0.2	2.0	3.8	6.5	2.0	7.0		C_L = 15 pF R_L = 1 MΩ	Figures 1, 3
		3.3 ± 0.3	1.5	2.8	4.5	1.4	5.0			
		5.0 ± 0.5	1.0	2.2	3.5	1.0	3.8			
		3.3 ± 0.3	2.0	3.4	5.5	1.6	6.2		C_L = 50 pF R_L = 500 Ω	Figures 1, 3
		5.0 ± 0.5	1.5	2.6	4.0	1.4	4.7			
t_{PHL}	Propagation Delay $\overline{C}$ to Q	1.65	2.5	9.8	13.5	2.5	15.0	ns		
		1.8	2.5	6.5	9.0	2.5	10.0			
		2.5 ± 0.2	2.0	3.8	6.0	2.0	6.4		C_L = 15 pF R_L = 1 MΩ	Figures 1, 3
		3.3 ± 0.3	1.5	2.8	4.3	1.2	4.6			
		5.0 ± 0.5	1.5	2.2	3.2	1.0	3.5			
		3.3 ± 0.3	1.5	3.4	5.3	1.5	5.8		C_L = 50 pF R_L = 500 Ω	Figures 1, 3
		5.0 ± 0.5	1.0	2.7	4.0	1.2	4.5			
t_S	Setup Time CP to D	2.5 ± 0.2				2.5		ns	C_L = 50 pF R_L = 500 Ω	Figures 1, 4
		3.3 ± 0.3				2.0				
		5.0 ± 0.5				1.5				
t_H	Hold Time, CP to D	2.5 ± 0.2				1.5		ns	C_L = 50 pF R_L = 500 Ω	Figures 1, 4
		3.3 ± 0.3				1.5				
		5.0 ± 0.5				1.5				
t_W	Pulse Width, CP	2.5 ± 0.2				3.0		ns	C_L = 50 pF R_L = 500 Ω	Figures 1, 4
		3.3 ± 0.3				2.8				
		5.0 ± 0.5				2.5				
	Pulse Width, $\overline{C}$	2.5 ± 0.2				3.0		ns	Clock HIGH or LOW C_L = 50 pF R_L = 500 Ω	Figures 1, 4
		3.3 ± 0.3				2.8				
		5.0 ± 0.5				2.5				
t_{rec}	Recovery Time, $\overline{C}$ to CP	2.5 ± 0.2				1.0		ns	C_L = 50 pF R_L = 500 Ω	Figures 1, 4
		3.3 ± 0.3				1.0				
		5.0 ± 0.5				1.0				

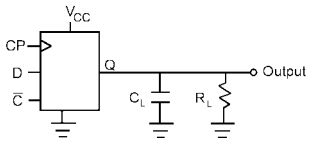
Capacitance (Note 3)

Symbol	Parameter	Typ	Max	Units	Conditions
C_{IN}	Input Capacitance	3		pF	V_{CC} = Open, V_{IN} = 0V or V_{CC}
C_{OUT}	Output Capacitance	4		pF	V_{CC} = 3.3V, V_{IN} = 0V or V_{CC}
C_{PD}	Power Dissipation Capacitance (Note 4)	10		pF	V_{CC} = 3.3V
		12			V_{CC} = 5.0V

Note 3: T_A = +25C, f = 1MHz.

Note 4: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2)
C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CC}static)$.

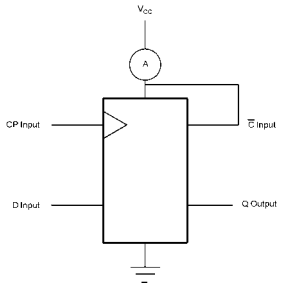
AC Loading and Waveforms



C_L includes load and stray capacitance

Input PRR = 1.0 MHz, t_w = 500 ns

FIGURE 1. AC Test Circuit



CP Input = AC Waveform; $t_r = t_f$ = 1.8 ns;

CP Input PRR = 10 MHz; Duty Cycle = 50%

D Input PRR = 5MHz; Duty Cycle = 50%

FIGURE 2. I_{CCD} Test Circuit

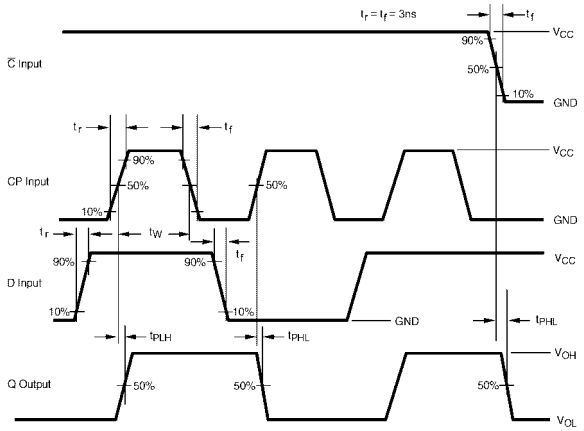


FIGURE 3. AC Waveforms

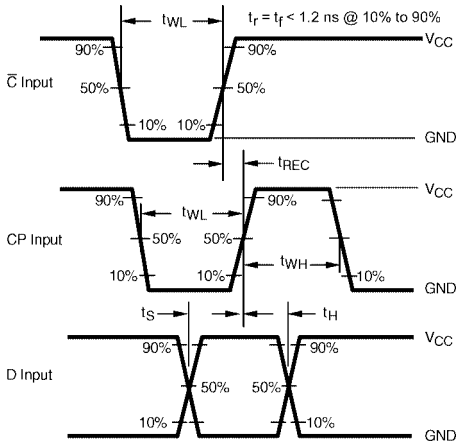


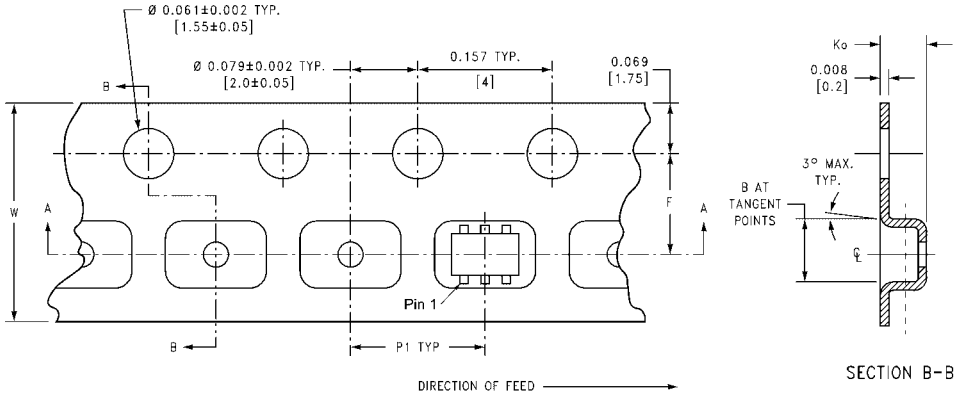
FIGURE 4. AC Waveforms

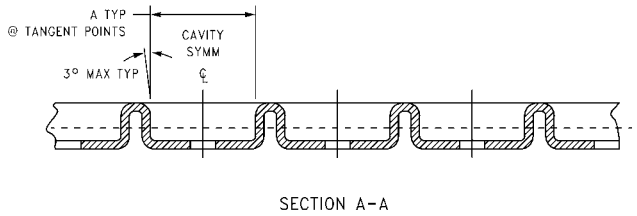
Tape and Reel Specification

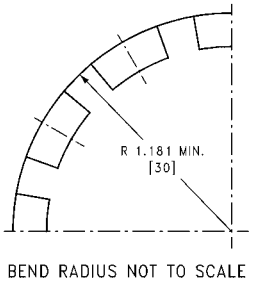
TAPE FORMAT for SC70

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
P6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)





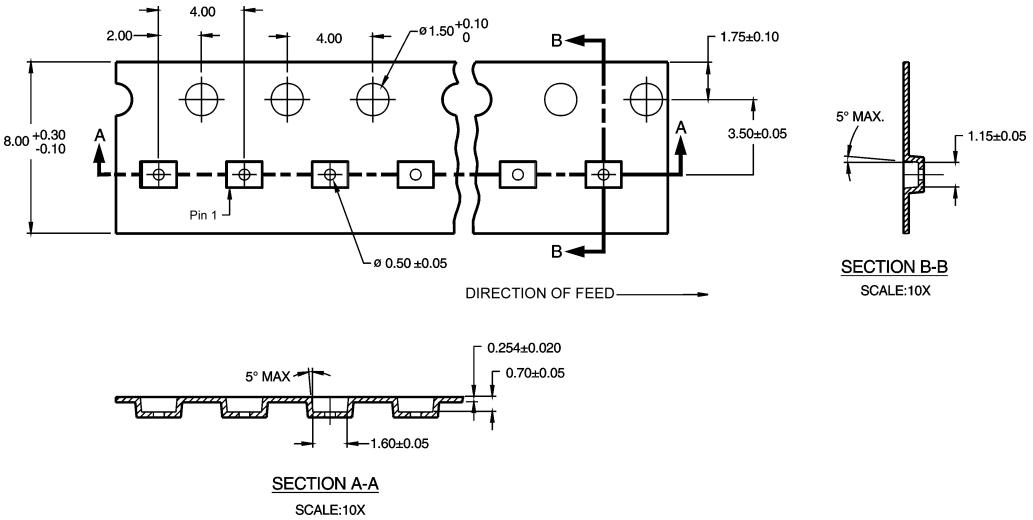


Package	Tape Size	DIM A	DIM B	DIM F	DIM K_o	DIM P1	DIM W
SC70-6	8 mm	0.093 (2.35)	0.096 (2.45)	0.138 ± 0.004 (3.5 ± 0.10)	0.053 ± 0.004 (1.35 ± 0.10)	0.157 (4)	0.315 ± 0.004 (8 ± 0.1)

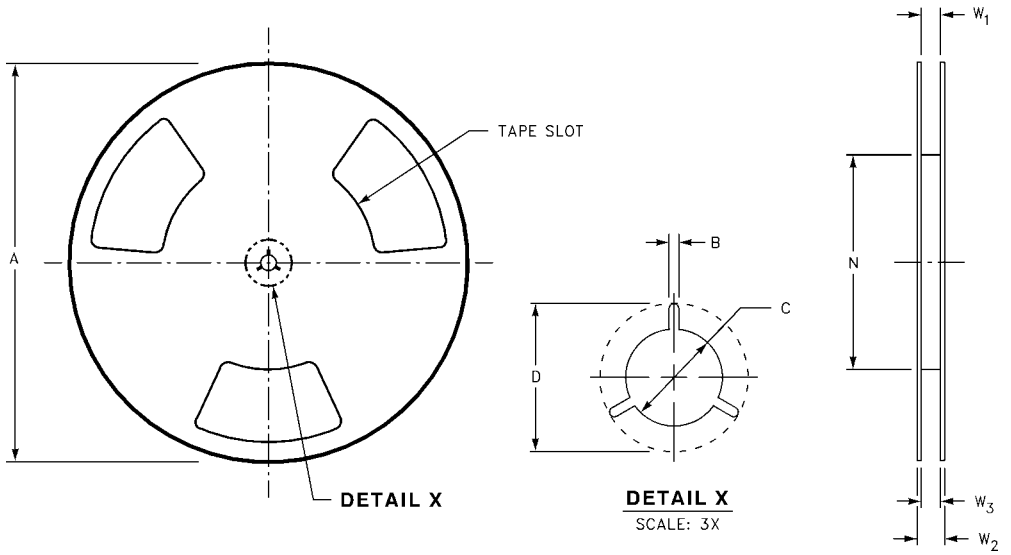
Tape and Reel Specification (Continued)

TAPE FORMAT for MicroPak

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

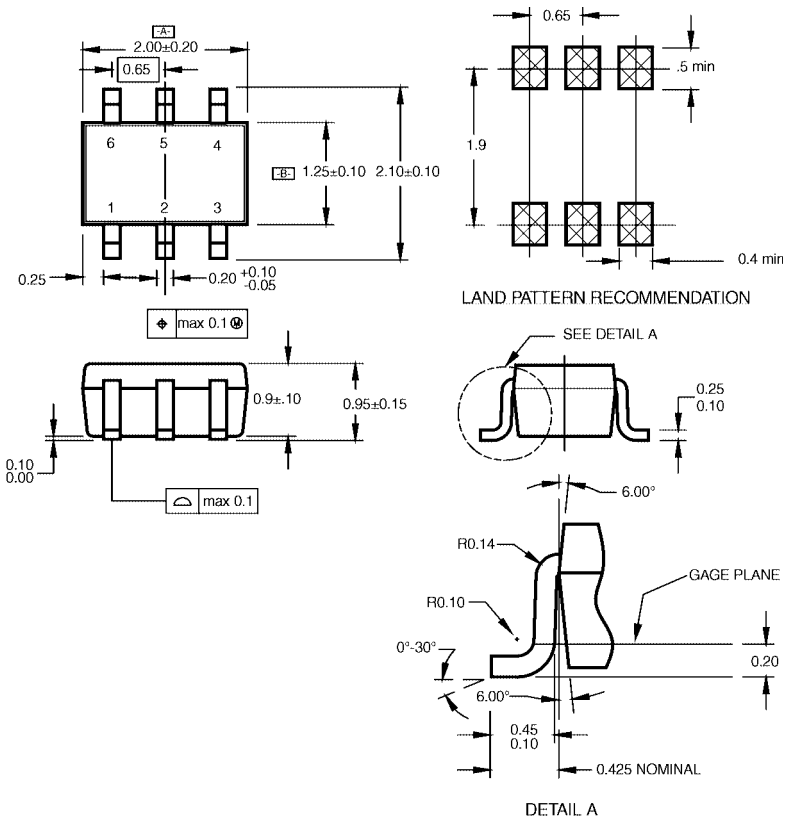


REEL DIMENSIONS inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/–0.000 (8.40 + 1.50/–0.00)	0.567 (14.40)	W1 + 0.078/–0.039 (W1 + 2.00/–1.00)

Physical Dimensions inches (millimeters) unless otherwise noted



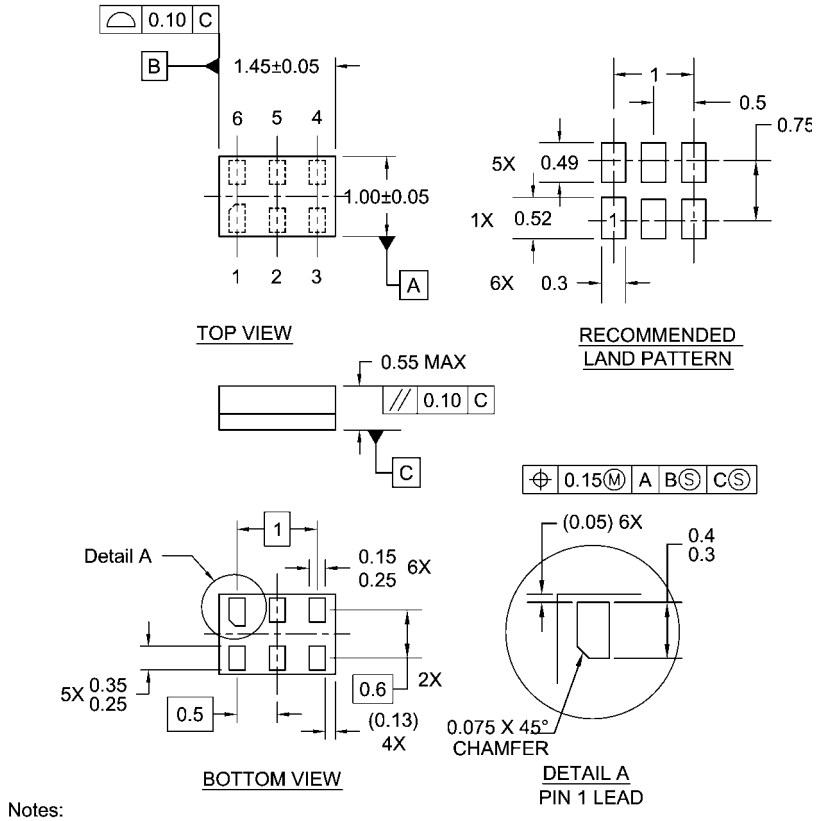
NOTES:

A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88.
B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
C. DIMENSIONS ARE IN MILLIMETERS.

MAA06ARevC

6-Lead SC70, EIAJ SC88, 1.25mm Wide
Package Number MAA06A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide
Package Number MAC06A

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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